

TAIWAN SEMICONDUCTOR PRODUCT/ PROCESS CHANGE NOTIFICATION

PRODUCT/ PROCESS CHANGE NOTIFICATION						
1. PCN No.:	QPCN12003					
2. Subject:	TSC label format/information change					
3. To:	All Sales					
4. Issued by:	Owen Wang					
5. Issue date:	21 st Feb., '12					
6. Proposed first ship date for change:	26 th May., '12					
7. Affected Product Identification						
All TSC DSD(Discrete Semiconductor Device)						
8. Change Description : (OLD Vs. NEW Con	-					
Old:	New:					
TSC label (See attached comparison report).	TSC label 2 nd revision (See attached comparison report).					
9. Reason for Change:						
 Add the identifier symbol to comply with new market trends. Add the customer P/N in barcode format. further details see attached comparison report. 10. Anticipated Impact: (form, fit, function, quality or reliability) Data sheet: No change Product: Reliability/performance: No change Inner construction: No change No change No change No change						
11.Qualification plan/result:						
N/A because product is not involved						
12. Sample availability Date:	For label example pls contact your regional TSC sales office					
13. Tentative implementation date:	26 th May., '12					
14. Remarks						
See attached comparison report.						
15. Customer feedback required latest: (should we receive no feedback; the change will be deemed as accepted!)	26 th May., '12					
16. Approved by:	Quayer Chen					



PRODUCT/ PROCESS CHANGE NOTIFICATION CUSTOMER APPROVAL FORM_QPCN12003

(Please check the appropriate field and provide any comments)

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	We agree with this proposed change and its schedule.					
	We have object	tions:				
We need more information:						
	We need sampl	les:				
	Tro Hood Gampi					
Company:						
Name:						
Add	lress:					
Sign	nature:		Date:			
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